

RS2A/A - RS2M/A

1.5A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features

- Glass Passivated Die Construction
- Fast Recovery Time For High Efficiency
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- Plastic Material: UL Flammability Classification Rating 94V-0

	SI	/IΑ	SMB					
Dim	Min	Max	Min	Max				
Α	2.29	2.92	3.30	3.94				
В	4.00	4.60	4.06	4.57				
С	1.27	1.63	1.96	2.21				
D	0.15	0.31	0.15	0.31				
Е	4.80	5.59	5.00	5.59				
G	0.10	0.20	0.10	0.20				
Н	0.76	1.52	0.76	1.52				
J	2.01	2.62	2.00	2.62				
All Dimensions in mm								

Mechanical Data

Case: Molded Plastic

 Terminals: Solder Plated Terminal -Solderable per MIL-STD-202, Method 208

- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.065 grams (approx.)
- SMB Weight: 0.09 grams (approx.)
- Mounting Position: Any
- Marking: Type Number

AA, BA, DA, GA, JA, KA, MA Suffix Designates SMA Package A, B, D, G, J, K Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	RS2 A/AA	RS2 B/BA	RS2 D/DA	RS2 G/GA	RS2 J/JA	RS2 K/KA	RS2 M/MA	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage		V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T _T = 120°C		lo	1.5							Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load (JEDEC Method)		I _{FSM}	50						А	
Forward Voltage @ I _F = 1.5A		V _{FM}	1.3						V	
Peak Reverse Current@ $T_A = 25^{\circ}C$ at Rated DC Blocking Voltage@ $T_A = 125^{\circ}C$		I _{RM}	5.0 200							μА
Reverse Recovery Time (Note 3)		t _{rr}	150 250 500				00	ns		
Typical Junction Capacitance (Note 2)		Cj	30							pF
Typical Thermal Resistance, Junction to Terminal (Note 1)		R _θ JT	20						K/W	
Operating and Storage Temperature Range		T _j , T _{STG}	-65 to +150						°C	

Notes:

- 1. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Reverse Recovery Test Conditions: $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.



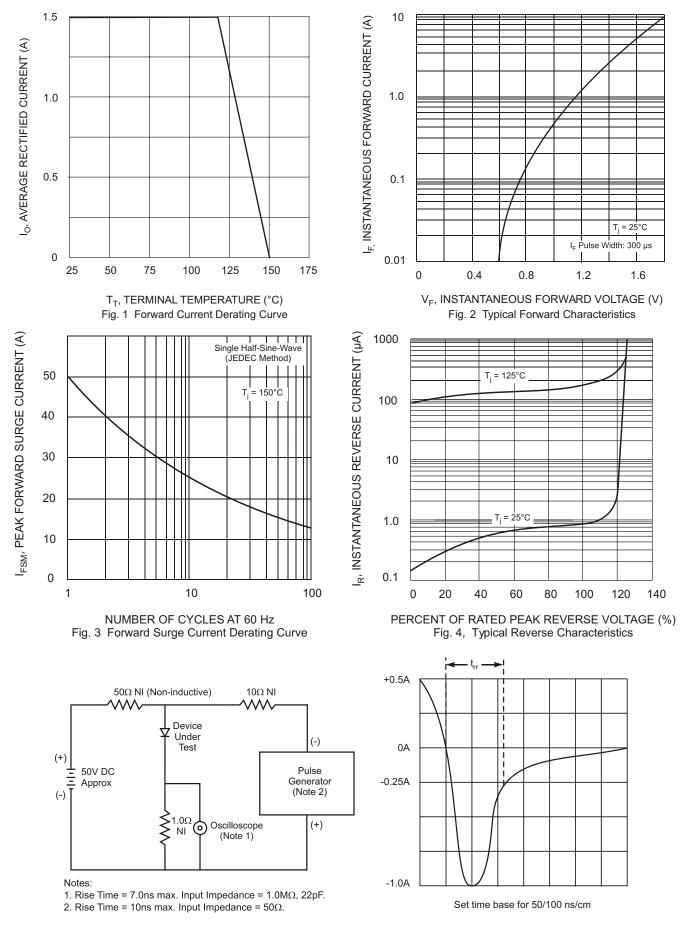


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit